P_D = 2 W Transient Voltage Suppressor **SJPZ-N Series**



Description

The SJPZ-N series are power Zener diodes designed for the protection of automotive electronic units, especially from the surge generated during load dump conditions and voltage transients induced by inductive loads. The package of the IC has high dissipation and high surge capability.

Features

- AEC-Q101 Qualified
- Meets the Surge Protection Requirements in ISO7637-2 Standrard (Pulse 1-3)
- High Reliability and Automotive Requirement
- High Surge Capability
- Flammability UL94V-0 (Equivalent)
- Bare Lead Frame: Pb-free (RoHS Compliant)

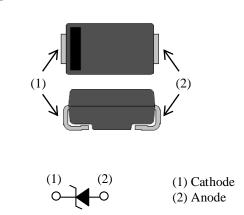
Applications

Protection of sensitive electronic equipment in passenger cars, trucks, vans, and buses:

- Engine Control Units
- Electric Control Units
- Braking System
- Power Steering System
- Airbag System
- Audio System
- Infotainment System

Package

SJP



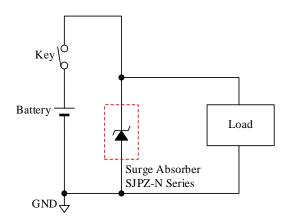
Not to scale

Selection Guide

Deut Namh an	Vz		D *	л	
Part Number	Min.	Max.	P _{RSM} *	P _D	
SJPZ-N18	16.8 V	19.1 V			
SJPZ-N27	25.1 V	28.9 V	500 W	2 W	
SJPZ-N33	31.0 V	35.0 V			

^{*500} μs, single block pulse

Typical Application



Contents

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Rating	Unit	Remarks
Power Dissipation ⁽¹⁾	PD	Lead temperature ⁽²⁾	2	W	
			13		SJPZ-N18
DC Blocking Voltage	V_{DC}	—	20	V	SJPZ-N27
			25		SJPZ-N33
Peak Reverse Power	P _{RSM}	500 μs, single block pulse	500	W	
Junction Temperature	T_{J}		-55 to 150	°C	
Storage Temperature	T _{STG}		-55 to 150	°C	

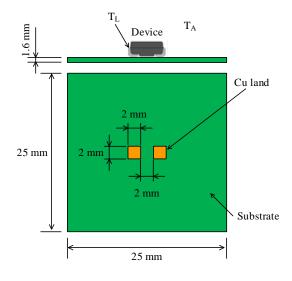


Figure 1. Lead Temperature Measurement Conditions

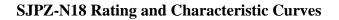
 ⁽¹⁾ See Figure 2.
 ⁽²⁾ See Figure 1.

Electrical Characteristics

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	Remarks
Forward Voltage Drop	V _F	$I_F\!=\!2~A$	_	_	1.20	V	
Reverse Leakage Current	I _R	$V_{R} = 13 V$			1	μΑ	SJPZ-N18
		$V_R = 20 V$			1		SJPZ-N27
		$V_R = 25 V$	_	_	1		SJPZ-N33
Breakdown Voltage	Vz	$I_Z = 1 mA$	16.8	_	19.1	v	SJPZ-N18
			25.1		28.9		SJPZ-N27
			31.0	_	35.0		SJPZ-N33
Breakdown Voltage Temperature Coefficient	r _Z	$I_Z = 1 mA$		13		mV/°C	SJPZ-N18
				23			SJPZ-N27
				29			SJPZ-N33
Breakdown Region Equivalent Resistance	Rz	$I_Z = 10 \text{ mA to } 20 \text{ mA}$		2		Ω	
				4			
				5			
				7			
Thermal Resistance	R _{th(J-L)}	(3)			20	°C/W	

 $^{^{(3)}}$ R_{th(J-L)} is thermal resistance between junction and lead. Lead temperature is measured as shown in Figure 1.



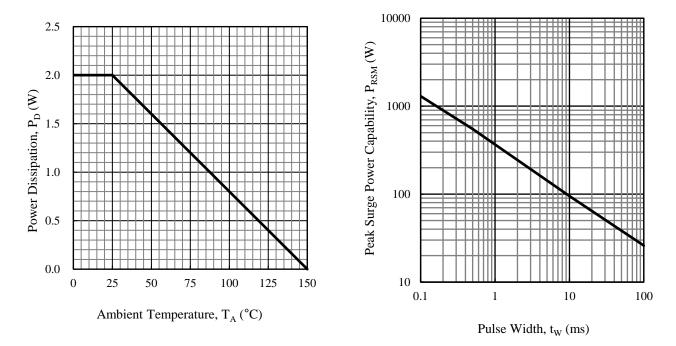


Figure 2. SJPZ-N18 Power Dissipation Curves⁽⁴⁾

Figure 3. SJPZ-N18 Peak Surge Reverse Power Capability⁽⁵⁾

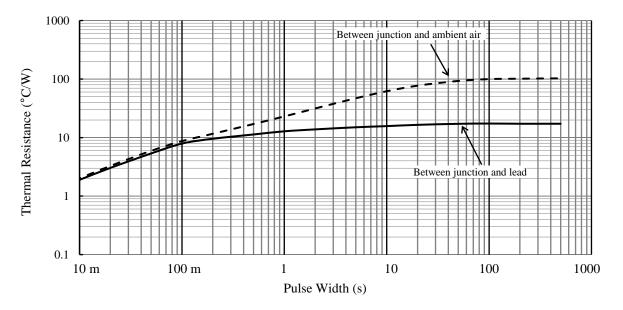


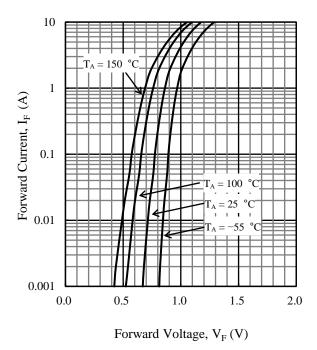
Figure 4. SJPZ-N18 Typical Transient Thermal Resistance⁽⁶⁾

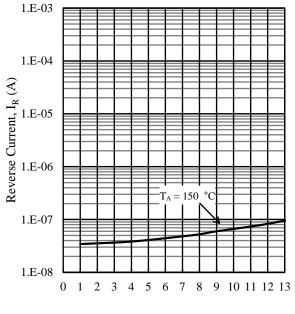
⁽⁴⁾ See Figure 1 for the measurement conditions of the lead temperature.

 $^{^{(5)}}$ tw is single block pulse.

⁽⁶⁾ See Figure 1 for the measurement conditions of the lead temperature.

SJPZ-N Series





Reverse Voltage, $V_R(V)$

Figure 5. SJPZ-N18 Typical Characteristics: IF vs. VF

Figure 6. SJPZ-N18 Typical Characteristics: I_R vs. V_R

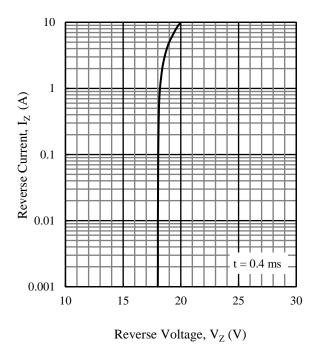


Figure 7. SJPZ-N18 Typical Characteristics: Iz vs. Vz

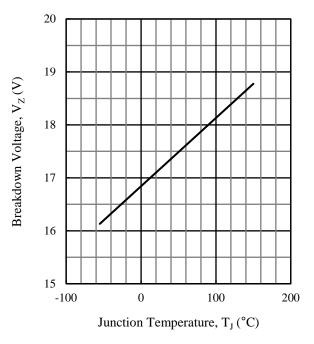


Figure 8. SJPZ-N18 Typical Characteristics: V_Z vs. T_J



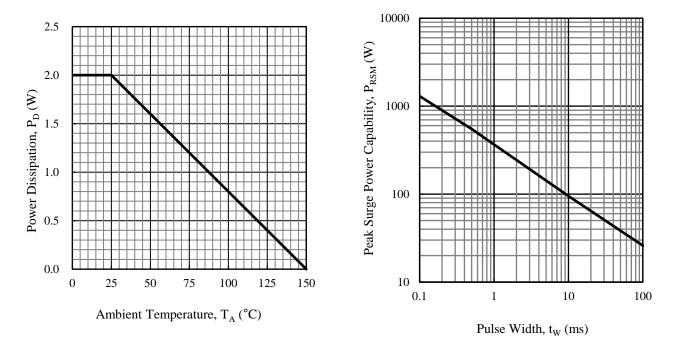


Figure 9. SJPZ-N27 Power Dissipation Curves⁽⁷⁾

Figure 10. SJPZ-N27 Peak Surge Reverse Power Capability⁽⁸⁾

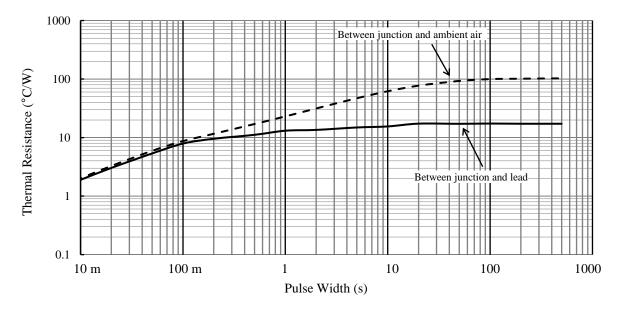


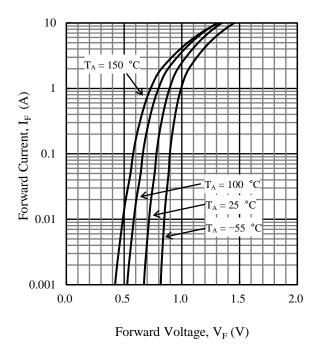
Figure 11. SJPZ-N27 Typical Transient Thermal Resistance⁽⁹⁾

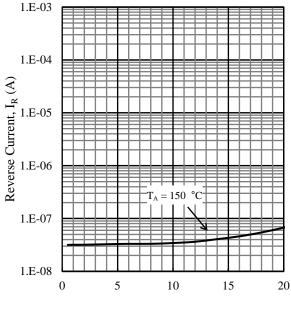
⁽⁷⁾ See Figure 1 for the measurement conditions of the lead temperature.

⁽⁸⁾ t_W is single block pulse..

⁽⁹⁾ See Figure 1 for the measurement conditions of the lead temperature.

SJPZ-N Series





Reverse Voltage, $V_R(V)$

Figure 12. SJPZ-N27 Typical Characteristics: IF vs. VF

Figure 13. SJPZ-N27 Typical Characteristics: I_R vs. V_R

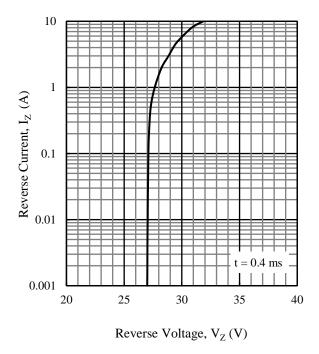


Figure 14. SJPZ-N27 Typical Characteristics: I_Z vs. V_Z

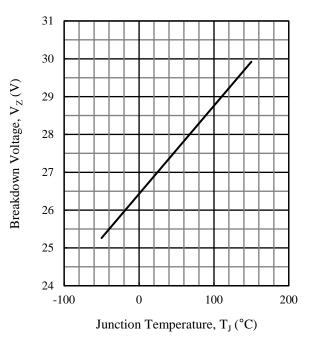


Figure 15. SJPZ-N27 Typical Characteristics: $V_Z vs. T_J$



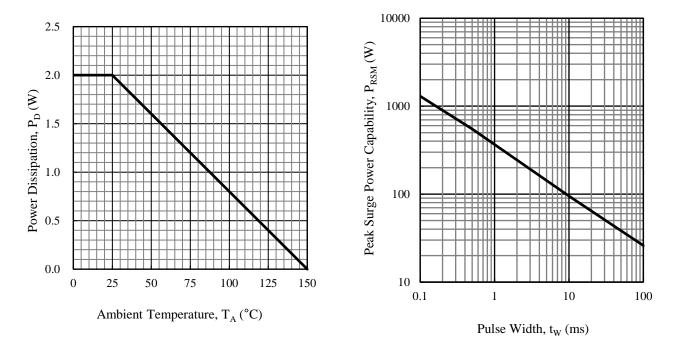


Figure 16. SJPZ-N33 Power Dissipation Curves⁽¹⁰⁾

Figure 17. SJPZ-N33 Peak Surge Reverse Power Capability⁽¹¹⁾

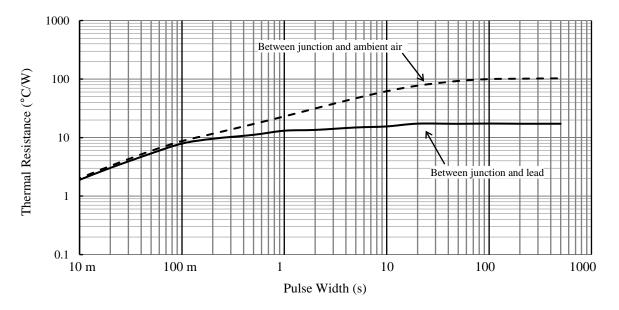
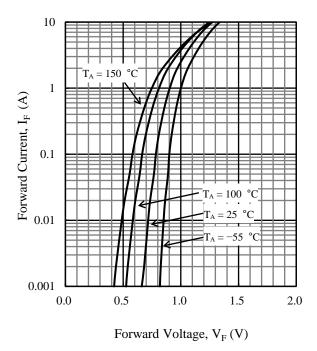


Figure 18. SJPZ-N33 Typical Transient Thermal Resistance⁽¹²⁾

⁽¹⁰⁾ See Figure 1 for the measurement conditions of the lead temperature.

⁽¹¹⁾ tw is single block pulse..

⁽¹²⁾ See Figure 1 for the measurement conditions of the lead temperature.



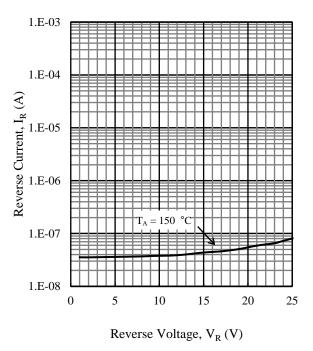


Figure 19. SJPZ-N33 Typical Characteristics: V_F vs. I_F

Figure 20. SJPZ-N33 Typical Characteristics: V_R vs. I_R

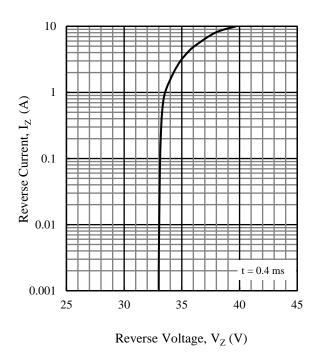


Figure 21. SJPZ-N33 Typical Characteristics: I_Z vs. V_Z

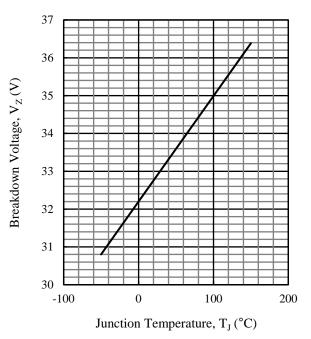
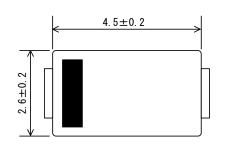
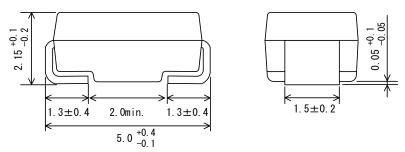


Figure 22. SJPZ-N33 Typical Characteristics: V_Z vs. T_J

Physical Dimensions

• SJP



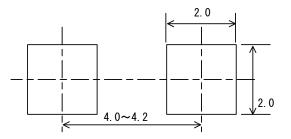


NOTES:

- Dimensions in millimeters
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, be sure to minimize the working time, within the following limits:
- MSL: JEDEC LEVEL1
- When soldering the products, it is required to minimize the working time, within the following limits: Flow: 260 ± 5 °C / 10 ± 1 s, 2 times

Soldering Iron: 380 \pm 10 $^{\circ}C$ / 3.5 \pm 0.5 s, 1 time

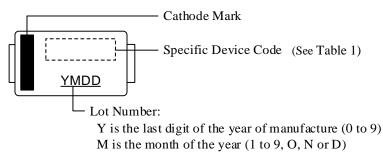
• SJP Land Pattern Example



NOTE:

- Dimensions in millimeters

Marking Diagram



DD is the day of the month (01 to 31)

Specific Device Code	Part Number		
ZN18	SJPZ-N18		
ZN27	SJPZ-N27		
ZN33	SJPZ-N33		

Table 1. Specific Device Code

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 human injury or death, fire accident or social harm which may result from any failure or malfunction of the Sanken Products.
 Please refer to the relevant specification documents and Sanken's official website in relation to derating.
- No anti-radioactive ray design has been adopted for the Sanken Products.
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